## NSDEMP11XV6T1, NSDEMP11XV6T5

# Common Anode Quad Array Switching Diode

These Common Anode Epitaxial Planar QUAD Diodes are designed for use in ultra high speed switching applications. The NSDEMP11XV6T1 device is housed in the SOT-563 package which is designed for low power surface mount applications, where board space is at a premium.

#### **Features**

- Fast t<sub>rr</sub>
- Low C<sub>D</sub>
- These are Pb–Free Devices

### **MAXIMUM RATINGS** $(T_A = 25^{\circ}C)$

| Rating                     | Symbol                    | Value | Unit |
|----------------------------|---------------------------|-------|------|
| Reverse Voltage            | V <sub>R</sub>            | 80    | Vdc  |
| Peak Reverse Voltage       | V <sub>RM</sub>           | 80    | Vdc  |
| Forward Current            | I <sub>F</sub>            | 100   | mAdc |
| Peak Forward Current       | I <sub>FM</sub>           | 300   | mAdc |
| Peak Forward Surge Current | I <sub>FSM</sub> (Note 1) | 2.0   | Adc  |

#### THERMAL CHARACTERISTICS

| Characteristic<br>(One Junction Heated)                                    | Symbol          | Max                                | Unit        |
|--|-----------------|------------------------------------|-------------|
| Total Device Dissipation $T_A = 25^{\circ}C$<br>Derate above $25^{\circ}C$ | P <sub>D</sub>  | 357<br>(Note 2)<br>2.9<br>(Note 2) | mW<br>mW/°C |
| Thermal Resistance, Junction-to-Ambient                                    | $R_{\theta JA}$ | 350<br>(Note 2)                    | °C/W        |
| Characteristic   |                 |                                    |             |
| (Both Junctions Heated)  | Symbol          | Max                                | Unit        |
| Total Device Dissipation $T_A = 25^{\circ}C$                               | $P_{D}$         | 500                                | mW          |
| Derate above 25°C  |                 | (Note 2)<br>4.0<br>(Note 2)        | mW/°C       |
| Derate above 25°C  Thermal Resistance, Junction-to-Ambient                 | $R_{	heta JA}$  | ` 4.0 ´                            | mW/°C       |

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

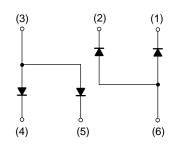
1.  $t = 1 \mu S$ 

2. FR-4 @ Minimum Pad



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SOT-563 CASE 463A PLASTIC

#### **MARKING DIAGRAM**



P9 = Device Code

M = Date Code

= Pb–Free Package

(Note: Microdot may be in either location)

### **ORDERING INFORMATION**

| Device        | F    | Package | Shipping <sup>†</sup> |
|---------------|------|---------|-----------------------|
| NSDEMP11XV6T  | ıs   | OT-563* | 4000/Tape & Reel      |
| NSDEMP11XV6T  | ig S | OT-563* | 4000/Tape & Reel      |
| NSDEMP11XV6T5 | 5 S  | OT-563* | 8000/Tape & Reel      |
| NSDEMP11XV6T  | G S  | OT-563* | 8000/Tape & Reel      |

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

<sup>\*</sup>This package is inherently Pb-Free.

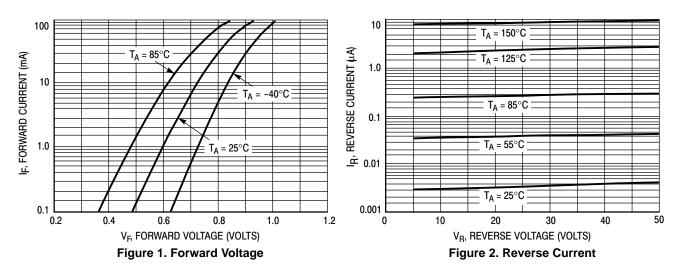
## NSDEMP11XV6T1, NSDEMP11XV6T5

## **ELECTRICAL CHARACTERISTICS** $(T_A = 25^{\circ}C)$

| Characteristic                  | Symbol                   | Condition   |   | Max | Unit |
|---------------------------------|--------------------------|---|---|-----|------|
| Reverse Voltage Leakage Current | I <sub>R</sub>           | V <sub>R</sub> = 70 V   | - | 0.1 | μAdc |
| Forward Voltage                 | V <sub>F</sub>           | I <sub>F</sub> = 100 mA   | _ | 1.2 | Vdc  |
| Reverse Breakdown Voltage       | V <sub>R</sub>           | I <sub>R</sub> = 100 μA   | 0 | -   | Vdc  |
| Diode Capacitance               | C <sub>D</sub>           | V <sub>R</sub> = 6.0 V, f = 1.0 MHz   | - | 3.5 | pF   |
| Reverse Recovery Time           | t <sub>rr</sub> (Note 3) | $I_F = 5.0 \text{ mA}, V_R = 6.0 \text{ V}, R_L = 100 \Omega, I_{rr} = 0.1 I_R$ | - | 4.0 | ns   |

<sup>3.</sup> t<sub>rr</sub> Test Circuit for NSDEMP11XV6T1 in Figure 4.

### TYPICAL ELECTRICAL CHARACTERISTICS



1.75
(La)
1.5
1.25
1.25
0.75
0
2
4
6
8
V<sub>B</sub>, REVERSE VOLTAGE (VOLTS)

Figure 3. Diode Capacitance

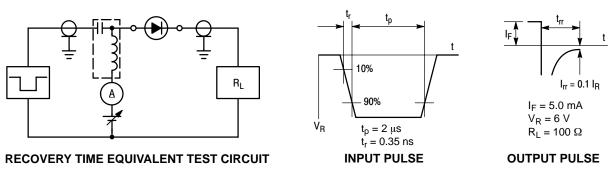
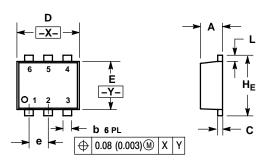


Figure 4. Reverse Recovery Time Test Circuit for the NSDEMP11XV6T1

### NSDEMP11XV6T1, NSDEMP11XV6T5

#### PACKAGE DIMENSIONS

SOT-563, 6 LEAD CASE 463A-01 ISSUE F

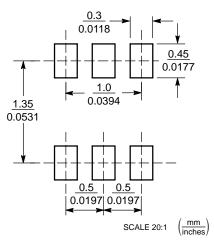


#### NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ANSI
- Y14.5M, 1982. 2. CONTROLLING DIMENSION: MILLIMETERS
- 3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.

|     | MILLIMETERS |      |      | INCHES   |       |       |  |
|-----|-------------|------|------|----------|-------|-------|--|
| DIM | MIN         | NOM  | MAX  | MIN      | NOM   | MAX   |  |
| Α   | 0.50        | 0.55 | 0.60 | 0.020    | 0.021 | 0.023 |  |
| b   | 0.17        | 0.22 | 0.27 | 0.007    | 0.009 | 0.011 |  |
| С   | 0.08        | 0.12 | 0.18 | 0.003    | 0.005 | 0.007 |  |
| D   | 1.50        | 1.60 | 1.70 | 0.059    | 0.062 | 0.066 |  |
| Е   | 1.10        | 1.20 | 1.30 | 0.043    | 0.047 | 0.051 |  |
| е   | 0.5 BSC     |      |      | 0.02 BSC |       |       |  |
| L   | 0.10        | 0.20 | 0.30 | 0.004    | 0.008 | 0.012 |  |
| HE  | 1.50        | 1.60 | 1.70 | 0.059    | 0.062 | 0.066 |  |

#### **SOLDERING FOOTPRINT\***



\*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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